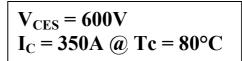
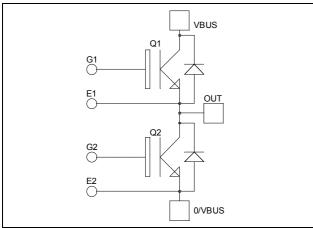
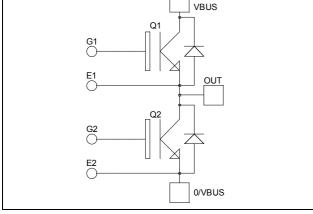


# Phase leg NPT IGBT Power Module







## **Application**

- Welding converters
- Switched Mode Power Supplies
- Uninterruptible Power Supplies
- Motor control

#### **Features**

- Non Punch Through (NPT) Fast IGBT
  - Low voltage drop
  - Low tail current
  - Switching frequency up to 100 kHz
  - Soft recovery parallel diodes
  - Low diode VF
  - Low leakage current
  - RBSOA and SCSOA rated
- Kelvin emitter for easy drive
- Very low stray inductance
  - Symmetrical design
  - M5 power connectors
- High level of integration

### **Benefits**

- Outstanding performance at high frequency operation
- Stable temperature behavior
- Very rugged
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Easy paralleling due to positive TC of VCEsat
- Low profile
- RoHS compliant

#### Absolute maximum ratings

Symbol	Parameter		Max ratings	Unit
$V_{CES}$	Collector - Emitter Breakdown Voltage		600	V
$I_{\rm C}$	Continuous Collector Current	$T_c = 25^{\circ}C$	430	
	Continuous Conector Current	$T_c = 80$ °C	350	A
$I_{CM}$	Pulsed Collector Current	$T_c = 25^{\circ}C$	1225	
$V_{GE}$	Gate – Emitter Voltage		±20	V
$P_{D}$	Maximum Power Dissipation	$T_c = 25^{\circ}C$	1562	W
RBSOA	Reverse Bias Safe Operating Area	$T_j = 150^{\circ}C$	800A @ 600V	

These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed. See application note APT0502 on www.microsemi.com



## All ratings @ $T_j = 25$ °C unless otherwise specified

### **Electrical Characteristics**

Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit
ī	Zero Gate Voltage Collector Current	$V_{GE} = 0V$	$T_j = 25$ °C			200	^
$I_{CES}$	Zero Gate Voltage Collector Current	$V_{CE} = 600V$	$T_j = 125$ °C			1750	μΑ
V	Collector Emitter saturation Voltage	$V_{GE} = 15V$	$T_j = 25$ °C		2.0	2.5	V
$V_{CE(sat)}$	Conector Emitter Saturation Voltage	$I_C = 360A$ $T_j = 125^{\circ}C$	$T_j = 125$ °C		2.2		·
$V_{GE(th)}$	Gate Threshold Voltage	$V_{GE} = V_{CE}, I_C = 4mA$		3		5	V
$I_{GES}$	Gate – Emitter Leakage Current	$V_{GE} = \pm 20V, V_{CE} = 0V$				±300	nA

**Dynamic Characteristics** 

•	Characteristic	Test Conditions		Min	Тур	Max	Unit
Cies	Input Capacitance	$V_{GE} = 0V$ $V_{CE} = 25V$			17.2		nF
$C_{oes}$	Output Capacitance				1.88		
$C_{res}$	Reverse Transfer Capacitance	f = 1MHz			1.6		
$Q_g$	Total gate Charge	$V_{GE} = 15V$			1320		
$Q_{ge}$	Gate – Emitter Charge	$V_{Bus} = 300V$			1160		nC
$Q_{gc}$	Gate – Collector Charge	$I_{\rm C} = 360 {\rm A}$		800			
$T_{d(on)}$	Turn-on Delay Time	Inductive Switching (25°C)			26		ns
$T_{r}$	Rise Time	$V_{GE} = 15V$		25			
$T_{d(off)}$	Turn-off Delay Time	$V_{Bus} = 400V$ $I_{C} = 360A$		150			
$T_{\mathrm{f}}$	Fall Time	$R_G = 1.25\Omega$		30			
$T_{d(on)}$	Turn-on Delay Time	Inductive Switching (125°C) $V_{GE} = 15V$ $V_{Bus} = 400V$ $I_{C} = 360A$ $R_{G} = 1.25\Omega$			26		ns
$T_{r}$	Rise Time				25		
$T_{d(off)}$	Turn-off Delay Time				170		
$T_{\rm f}$	Fall Time				40		
Eon	Turn-on Switching Energy	$V_{GE} = 15V$ $V_{Bus} = 400V$	$T_j = 125$ °C		17.2		mJ
E <sub>off</sub>	Turn-off Switching Energy	$I_C = 360A$ $R_G = 1.25\Omega$	$T_j = 125$ °C		14		1113

Reverse diode ratings and characteristics

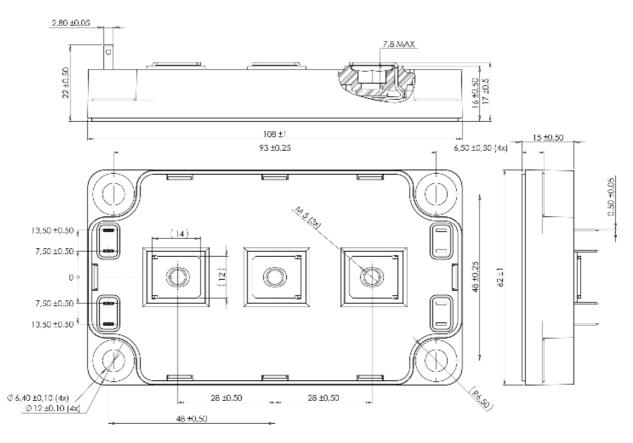
Symbol	Characteristic	Test Conditions		Min	Тур	Max	Unit
$V_{RRM}$	Maximum Peak Repetitive Reverse Voltage			600			V
$I_{RM}$	Maximum Reverse Leakage Current	V <sub>R</sub> =600V	$T_j = 25$ °C			750	۸
1 <sub>RM</sub>			$T_j = 125$ °C			1500	μA
$I_F$	DC Forward Current		Tc = 80°C		400		A
	Diode Forward Voltage	$I_F = 400A$			1.6	1.8	
$V_{\mathrm{F}}$		$I_F = 800A$			1.9		V
		$I_F = 400A$	$T_j = 125$ °C		1.4		
t <sub>rr</sub>	Reverse Recovery Time	$I_F = 400A$ $V_R = 400V$ $di/dt = 800A/\mu s$	$T_j = 25$ °C		180		ns
			$T_{j} = 125^{\circ}C$		220		115
$Q_{rr}$	Reverse Recovery Charge		$T_j = 25$ °C		1560		пC
		$T_{\rm j} = 125^{\circ}$			5800		iiC



## Thermal and package characteristics

Symbol	Characteristic			Min	Тур	Max	Unit
$R_{\text{thJC}}$	Junction to Case Thermal Resistance IGBT Diode				0.08	°C/W	
			Diode			0.16	C/ VV
$V_{ISOL}$	RMS Isolation Voltage, any terminal to case t =1 min, 50/60Hz			4000			V
$T_{J}$	Operating junction temperature range		-40		150	°C	
$T_{STG}$	Storage Temperature Range			-40			125
$T_{\rm C}$	Operating Case Temperature			-40		100	
Torque	Mounting torque	To heatsink	M6	3		5	N.m
		For terminals	M5	2		3.5	
Wt	Package Weight	·				300	g

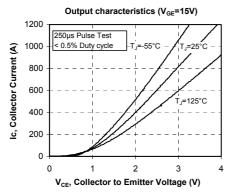
### SP6 Package outline (dimensions in mm)

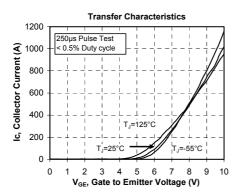


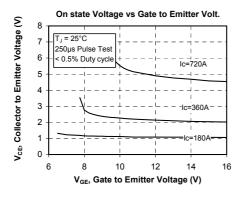
See application note APT0601 - Mounting Instructions for SP6 Power Modules on www.microsemi.com

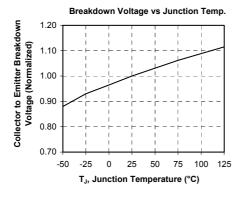


### **Typical Performance Curve**



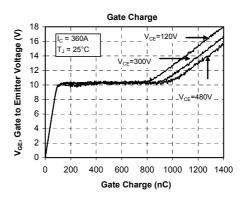


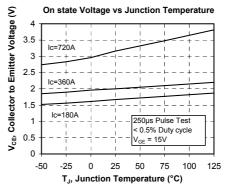


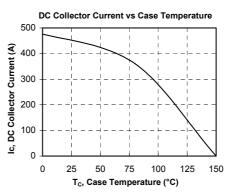


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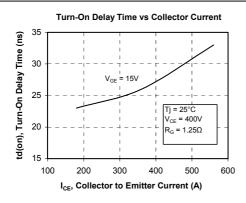
V<sub>CE</sub>, Collector to Emitter Voltage (V)

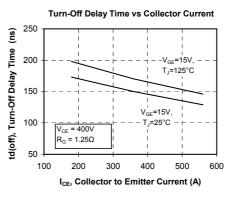


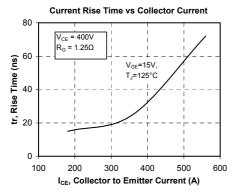


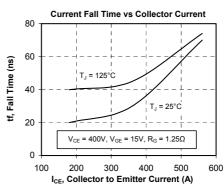


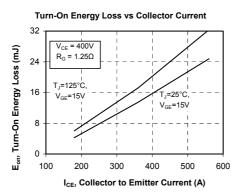


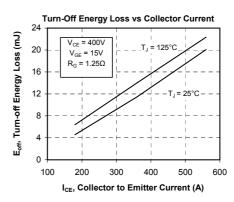


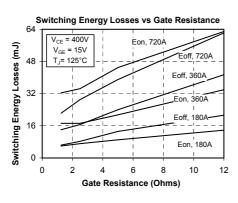


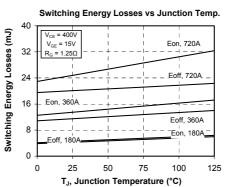




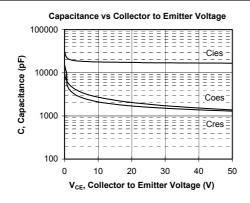


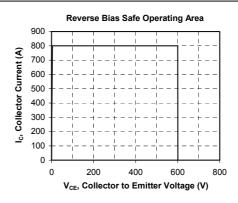




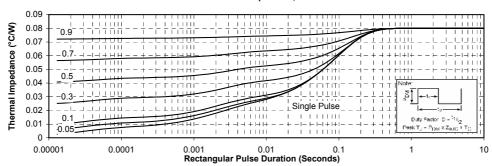


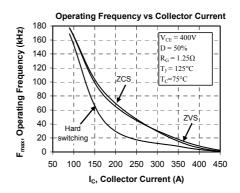






#### Maximum Effective Transient Thermal Impedance, Junction to Case vs Pulse Duration







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